## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YEN-CHENG LU	02/27/2014
SHINN-SHENG YU	02/27/2014
JENG-HORNG CHEN	03/03/2014
ANTHONY YEN	03/07/2014

### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	NO. 8, LI-HSIN ROAD 6	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSIN-CHU	
State/Country:	TAIWAN	
Postal Code:	300-77	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15044003

#### **CORRESPONDENCE DATA**

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Total Attachments O	
DATE SIGNED:	02/15/2016
SIGNATURE:	/LaDonna Johnson/
NAME OF SUBMITTER:	LADONNA JOHNSON
ATTORNEY DOCKET NUMBER:	24061.2743US02

Total Attachments: 2

PATENT REEL: 037736 FRAME: 0647

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PATENT REEL: 037736 FRAME: 0648

Attorney Docket No. 2013-0426/24061.2743 Customer No.: 42717

#### ASSIGNMENT

WHEREAS, we,

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(1)	Yen-Cheng Lu	of	2F., No.12, Lane 31, Section 1 Sanmin Road, Banqiao District New Taipei City 220, Taiwan, R.O.C.
(2)	Shinn-Sheng Yu	of	4F-2, No. 16, Lane 634, Nanda Road Hsinchu, Taiwan, R.O.C.
(3)	Jeng-Horng Chen	of	1, Alley 2, Lane 45, Fu-Chyun Street Hsin-Chu, Taiwan, R.O.C.
(4)	Anthony Yen	of	20F-9, 188 Guanxin Road, Hsinchu 300 Taiwan, R.O. C.

have invented certain improvements in

# AN EXTREME ULTRAVIOLET LITHOGRAPHY PROCESS AND MASK WITH REDUCED SHADOW EFFECT AND ENHANCED INTENSITY

for which we have executed an application for Letters Patent of the United States of America,

X of even date filed herewith; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

filed on \_\_\_\_\_\_ and assigned application number \_\_\_\_\_; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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AND. WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Yen-Cheng Lu	
Residence Address:	2F., No.12, Lane 31, Section 1, New Taipei City 220, Taiwan,	Sanmin Road, Banqiao District R.O.C.
Dated: <u> </u>	×14	Yen-Oheng Lu Inventor Signature
Inventor Name:	Shinn-Sheng Yu	
Residence Address:  Oated:		Road, Hsinchu, Taiwan, R.O.C.  Shiam-Shing Use Inventor Signature
Inventor Name:	Jeng-Horng Chen	
Residence Address:	1, Alley 2, Lane 45, Fu-Chyun	Street, Hsin-Chu, Taiwan, R.O.C.
Dated:/	'>>14	Inventor Signature
Inventor Name:	Anthony Yen	
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Dated: $3/7/2$	2014	Inventor Signature

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